

PSMN018-100ESF

NextPower 100 V, 18 m Ω N-channel MOSFET in I2PAK package

10 April 2017

Product data sheet

1. General description

NextPower 100 V standard level gate drive MOSFET. Qualified to 175 °C and recommended for industrial & consumer applications.

2. Features and benefits

- Optimised for fast switching, low spiking, high efficiency
- Low Q_G x R_{DSon} FOM for high efficiency switching applications
- Low body diode losses (Q_{rr}) and fast recovery (t_{rr})
- Strong avalanche energy rating (E_{AS})
- Avalanche rated & 100% tested
- Ha-free & RoHS compliant I2PAK low-height package

3. Applications

- Synchronous rectification in AC-to-DC and DC-to-DC applications
- Brushed & BLDC motor control
- · UPS & solar inverter
- · LED lighting
- · Battery protection
- Full-bridge & half-bridge applications
- Flyback & resonant topologies

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	-	100	V	
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	-	53	Α	
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	111	W	
Tj	junction temperature			-55	-	175	°C	
Static charact	eristics							
R _{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_D = 15 A; T_j = 25 °C; Fig. 10		-	15	18	mΩ	
		V_{GS} = 10 V; I_D = 15 A; T_j = 100 °C; Fig. 11		-	22	28	mΩ	
Dynamic characteristics								
Q_{GD}	gate-drain charge	I _D = 15 A; V _{DS} = 50 V; V _{GS} = 10 V;		-	4.2	-	nC	
Q _{G(tot)}	total gate charge	Fig. 12; Fig. 13		-	21.4	-	nC	



Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Avalanche rug	Avalanche ruggedness						
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	I_D = 20.5 A; $V_{sup} \le 100$ V; R_{GS} = 50 Ω; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; <u>Fig. 4</u> ; Unclamped	[2]	-	-	109	mJ

- [1] Avalanche current is limited by I_{AS}
- [2] Protected by 100% test

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate	mb	D
2	D	drain		
3	S	source		G P
mb	D	mounting base; connected to drain		mbb076 S
			I2PAK (SOT226)	

6. Ordering information

Table 3. Ordering information

Type number	Package	ckage				
	Name	Description	Version			
PSMN018-100ESF	I2PAK	plastic, single-ended package (I2PAK); 3 terminals; 2.54 mm pitch; 11 mm x 10 mm x 4.3 mm body	SOT226			

7. Marking

Table 4. Marking codes

Type number	Marking code
PSMN018-100PSF	PSMN018-100PSF

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	100	V
V_{DGR}	drain-gate voltage	25 °C ≤ T_j ≤ 175 °C; R_{GS} = 20 kΩ		-	100	V
V_{GS}	gate-source voltage			-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	111	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	53	Α
		V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u>		-	37	Α
I _{DM}	peak drain current	pulsed; $t_p \le 10 \mu s$; $T_{mb} = 25 °C$; Fig. 3		-	212	Α
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
$T_{sld(M)}$	peak soldering temperature			-	260	°C
Source-drain	diode			,	,	
Is	source current	T _{mb} = 25 °C		-	53	Α
I _{SM}	peak source current	pulsed; $t_p \le 10 \mu s$; $T_{mb} = 25 ^{\circ}C$		-	212	Α
Avalanche ru	iggedness			·		
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	I_D = 20.5 A; $V_{sup} \le 100$ V; R_{GS} = 50 Ω; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; Fig. 4; Unclamped	[2]	-	109	mJ
I _{AS}	non-repetitive avalanche current	$V_{sup} \le 100 \text{ V}; V_{GS} = 10 \text{ V}; T_{j(init)} = 25 \text{ °C};$ $R_{GS} = 50 \Omega$	[2]	-	20.5	A

^[1] Avalanche current is limited by IAS

^[2] Protected by 100% test

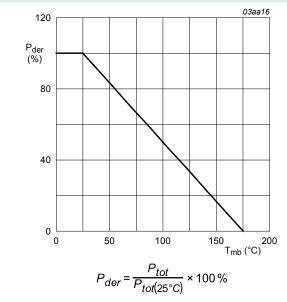


Fig. 1. Normalized total power dissipation as a function of mounting base temperature

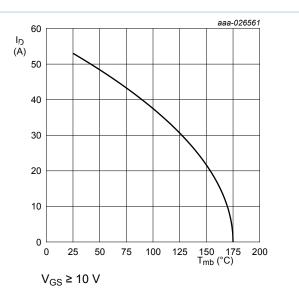
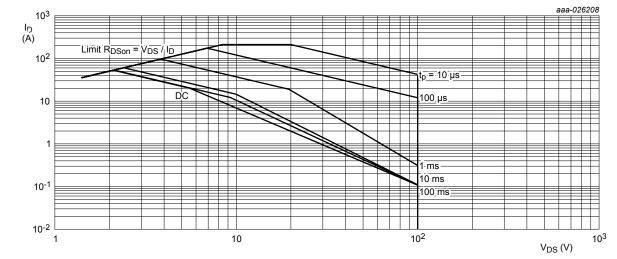
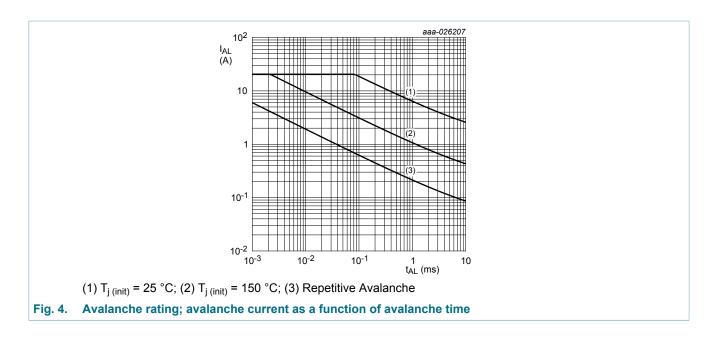


Fig. 2. Continuous drain current as a function of mounting base temperature



T_{mb} = 25 °C; I_{DM} is a single pulse

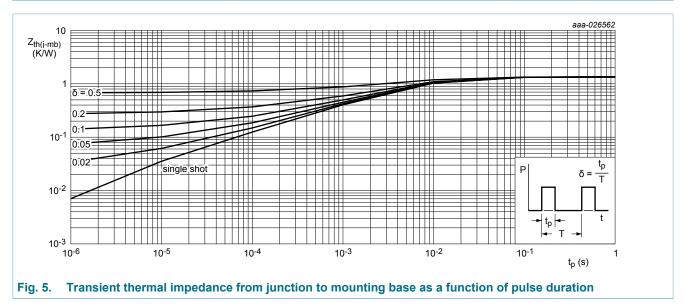
Fig. 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage



9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 5	-	1.22	1.35	K/W



10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V _{(BR)DSS}	drain-source	$I_D = 250 \mu A; V_{GS} = 0 V; T_j = 25 °C$	100	-	-	V
	breakdown voltage	$I_D = 250 \mu A; V_{GS} = 0 V; T_j = -55 °C$	90	-	-	V
$V_{GS(th)}$	gate-source threshold	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C}$	-	3.6	-	V
	voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C}$	-	2.1	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}; Fig. 9$	2	3.2	4	V
$\Delta V_{GS(th)}/\Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T _j ≤ 175 °C	-	-7.1	-	mV/K
I _{DSS}	drain leakage current	V _{DS} = 100 V; V _{GS} = 0 V; T _j = 25 °C	-	0.01	1	μA
		V _{DS} = 100 V; V _{GS} = 0 V; T _j = 125 °C	-	-	100	μΑ
I _{GSS}	gate leakage current	V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	5	100	nA
		V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	5	100	nA
R _{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I_{D} = 15 A; T_{j} = 25 °C; Fig. 10	-	15	18 mΩ	mΩ
		V _{GS} = 7 V; I _D = 15 A; T _j = 25 °C; <u>Fig. 10</u>	-	17.9	27	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 100 °C; Fig. 11	-	22	28	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 175 °C; Fig. 11	-	31	40	mΩ
R_G	gate resistance	f = 1 MHz	-	1.58	-	Ω
Dynamic cha	aracteristics					
$Q_{G(tot)}$	total gate charge	I _D = 15 A; V _{DS} = 50 V; V _{GS} = 10 V; Fig. 12; Fig. 13	-	21.4	_	nC
		$I_D = 0 A; V_{DS} = 0 V; V_{GS} = 10 V$	-	10.9	-	nC
Q_GS	gate-source charge	$I_D = 15 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$	-	7.2	-	nC
Q _{GS(th)}	pre-threshold gate- source charge	Fig. 12; Fig. 13	-	4.3	-	nC
Q _{GS(th-pl)}	post-threshold gate- source charge		-	2.9	-	nC
Q_{GD}	gate-drain charge		-	4.2	-	nC
$V_{GS(pl)}$	gate-source plateau voltage	I _D = 15 A; V _{DS} = 50 V; <u>Fig. 12</u> ; <u>Fig. 13</u>	-	4.9	-	V
C _{iss}	input capacitance	$V_{DS} = 50 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$	-	1482	-	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 14</u>	-	280	-	pF
C _{rss}	reverse transfer capacitance		-	13	-	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 50 \text{ V}; R_L = 3.3 \Omega; V_{GS} = 10 \text{ V};$	-	10.2	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 °C$	-	14.1	_	ns

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
t _{d(off)}	turn-off delay time			-	17.3	-	ns
t _f	fall time			-	12.6	-	ns
Source-drain	Source-drain diode						
V_{SD}	source-drain voltage	$I_S = 15 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C}; Fig. 15$		-	0.9	1.2	V
t _{rr}	reverse recovery time	$I_S = 15 \text{ A}; dI_S/dt = -100 \text{ A/}\mu\text{s}; V_{GS} = 0 \text{ V};$		-	40	-	ns
Q _r	recovered charge	V _{DS} = 50 V; <u>Fig. 16</u>		-	46	-	nC

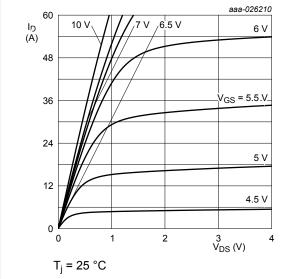


Fig. 6. Output characteristics; drain current as a function of drain-source voltage; typical values

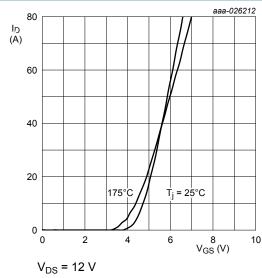


Fig. 8. Transfer characteristics; drain current as a function of gate-source voltage; typical values

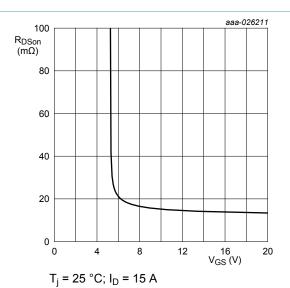


Fig. 7. Drain-source on-state resistance as a function of gate-source voltage; typical values

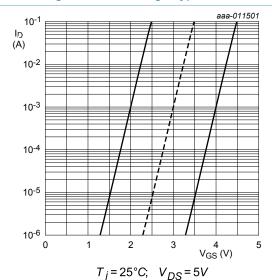


Fig. 9. Sub-threshold drain current as a function of gate-source voltage

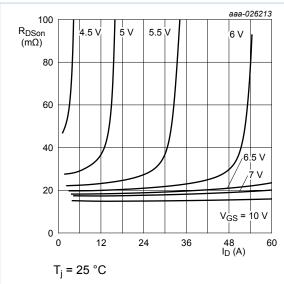


Fig. 10. Drain-source on-state resistance as a function of drain current; typical values

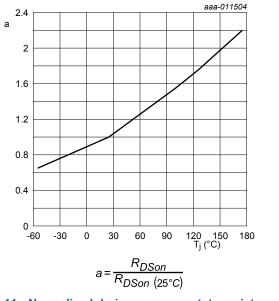


Fig. 11. Normalized drain-source on-state resistance factor as a function of junction temperature

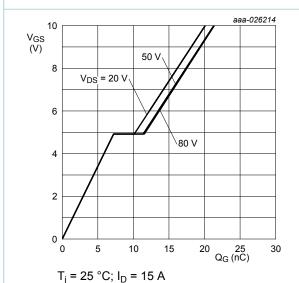


Fig. 12. Gate-source voltage as a function of gate charge; typical values

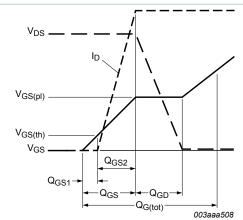


Fig. 13. Gate charge waveform definitions

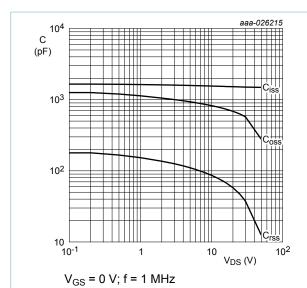
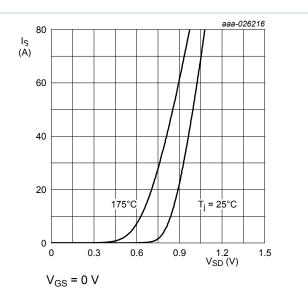


Fig. 14. Input, output and reverse transfer capacitances | Fig. 15. Source-drain (diode forward) current as a as a function of drain-source voltage; typical values



function of source-drain (diode forward) voltage; typical values

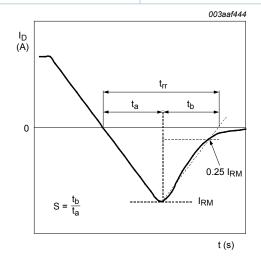


Fig. 16. Reverse recovery timing definition

11. Package outline

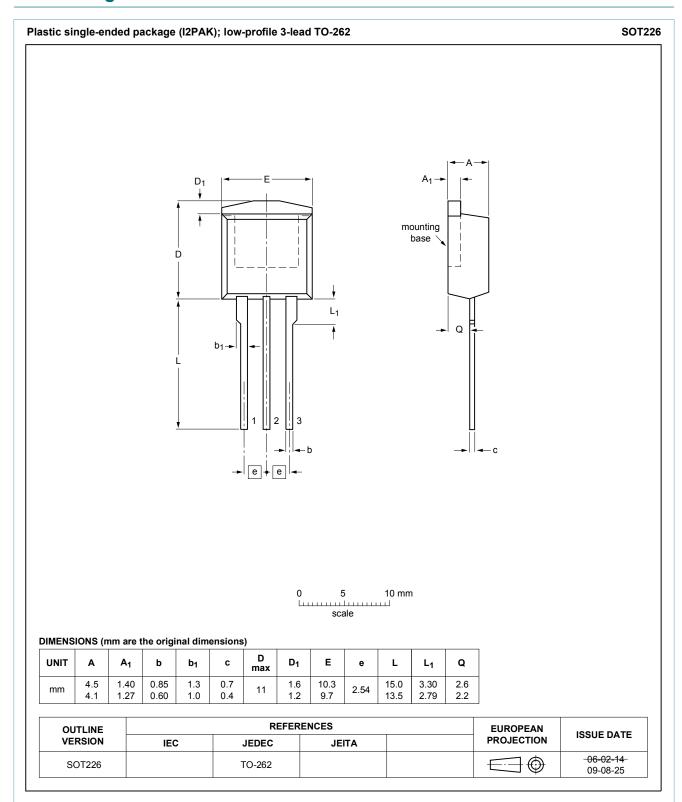


Fig. 17. Package outline I2PAK (SOT226)

12. Legal information

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Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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